



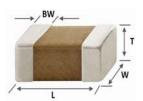
Specification of Automotive MLCC (Reference sheet)

● Supplier : Samsung electro-mechanics ● Samsung P/N : CL21C270JB61PNC

● AEC-Q200 Qualified

A. Dimension

Dimension



Size	0805 inch
L	2.00±0.10 mm
W	1.25±0.10 mm
Т	0.60±0.10 mm
BW	0.50+0.20/-0.30 mm

B. Samsung Part Number

<u>CL</u>	<u>21</u>	<u>C</u>	<u>270</u>	<u>J</u>	<u>B</u>	<u>6</u>	<u>1</u>	<u>P</u>	<u>N</u>	<u>C</u>
①	2	3	4	(5)	⑥	⑦	8	9	10	11

① Series	Samsung Multi-layer Ceramic Capacitor		
② Size	0805 (inch code)	L: 2.00±0.10 mm	W: 1.25±0.10 mm
3 Dielectric	C0G	® Inner electrode	Ni
Capacitance	27 pF	Termination	Cu
⑤ Capacitance	± 5%	Plating	Sn 100% (Pb Free)
tolerance		9 Product	Automotive
Rated Voltage	50 V	Special code	Normal
① Thickness	0.60±0.10 mm	1 Packaging	Cardboard Type, 7" Reel

C. Reliability Test and Judgement condition

	Performance	Test condition		
High Temperature	Appearance : No abnormal exterior appearance	Unpowered, 1,000hrs @ Max. temperature		
Exposure	Capacitance Change: Within ±2.5% or ±0.25pF	Measurement at 24±2hrs after test conclusion		
	whichever is larger			
	Q: 940 min.			
	IR : More than 10,000 № or 500 №× µF			
	Whichever is smaller			
Temperature Cycling	Appearance : No abnormal exterior appearance	1,000Cycles		
	Capacitance Change: Within ±2.5% or ±0.25pF	Measurement at 24±2hrs after test conclusion		
	whichever is larger			
	Q: 940 min.	1 cycle condition: -55+0/-3°C(30±3min) → Room Temp. (1min)		
	IR : More than 10,000 № or 500 №× µF	\rightarrow 125+3/-0 °C (30±3min) \rightarrow Room Temp. (1min)		
	Whichever is smaller			
Destructive Physical	No Defects or abnormalities	Per EIA 469		
Analysis				
Humidity Bias	Appearance : No abnormal exterior appearance	1,000hrs 85 ℃/85%RH, Rated Voltage and 1.3~1.5V,		
	Capacitance Change: Within ±2.5% or ±0.25pF	Add 100kohm resistor		
	whichever is larger			
	Q: 189.91 min.	The charge/discharge current is less than 50mA.		
	IR : More than 500 MΩ or 25 MΩ×μF			
	Whichever is smaller			
High Temperature	Appearance : No abnormal exterior appearance	1,000hrs @ 125 ℃, 200% Rated Voltage,		
Operating Life	Capacitance Change: Within ±3% or ±0.3pF	Measurement at 24±2hrs after test conclusion		
	whichever is larger	The charge/discharge current is less than 50mA.		
	Q: 342.5 min.			
	IR : More than 1,000 ™ or 50 ™× µF			
	Whichever is smaller			

	Performance	Test condition			
External Visual	No abnormal exterior appearance	Microscope ('10)			
Physical Dimensions	Within the specified dimensions	Using The calipers			
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Mechanical Shock	Appearance : No abnormal exterior appearance	Three shocks in each direction should be applied along			
	Capacitance Change: Within ±2.5% or ±0.25pF	3 mutually perpendicular axes of the test specimen (18 shocks)			
	whichever is larger	Peak value Duration Wave Velocity			
		1,500G 0.5ms Half sine 4.7m/sec			
	Q, IR: Initial spec.				
Vibration	Appearance : No abnormal exterior appearance	5g's for 20min., 12cycles each of 3 orientations,			
	Capacitance Change: Within ±2.5% or ±0.25pF	Use 8"×5" PCB 0.031" Thick 7 secure points on one long side			
	whichever is larger	and 2 secure points at corners of opposite sides. Parts mounted			
		within 2" from any secure point. Test from 10~2,000Hz.			
	Q, IR: Initial spec.				
Resistance to	Appearance : No abnormal exterior appearance	Preheating : 150°C for 60~120 sec.			
Solder Heat	Capacitance Change: Within ±2.5% or ±0.25pF	Solder pot : 260±5℃, 10±1sec.			
	whichever is larger				
	Q, IR: Initial spec.				
ESD	Appearance : No abnormal exterior appearance	AEC-Q200-002 or ISO/DIS10605			
	Capacitance Change: Within ±2.5% or ±0.25pF				
	whichever is larger				
	Q, IR: Initial spec.				
Solderability	95% of the terminations is to be soldered	a) Preheat at 155 °C for 4 hours, Immerse in solder for 5s at 245±5 °C			
	evenly and continuously	b) Steam aging for 8 hours, Immerse in solder for 5s at 245±5 °C			
		c) Steam aging for 8 hours, Immerse in solder for 120s at 260±5 ℃			
		solder : a solution ethanol and rosin			
Electrical	Capacitance : Within specified tolerance	The Capacitance / D.F. should be measured at 25 $^{\circ}\!$			
Characterization	Q: 940 min.	1 № ± 10%, 0.5~5 Vrms			
	IR(25 °C): More than 100,000 $M\Omega$ or 1,000 $M\Omega \times \mu$ F	I.R. should be measured with a DC voltage not exceeding			
	Whichever is smaller.	Rated Voltage @25℃, @125℃ for 60~120 sec.			
	IR(125℃): More than 10,000 ^M Ω or 100 ^M Ω×μ ^F				
	Whichever is smaller.				
	Dielectric Strength	Dielectric Strength : 300% of the rated voltage for 1~5 seconds			
Board Flex	Appearance : No abnormal exterior appearance	Bending to the limit, 3 mm for 60 seconds			
	Capacitance Change: Within ±5% or ±0.5pF				
	whichever is larger	40 NJ for CO and			
Terminal	Appearance : No abnormal exterior appearance	18 N, for 60 sec.			
Strength(SMD)	Capacitance Change: Within ±2.5% or ±0.25pF				
	whichever is larger	D			
Beam Load	Destruction value should be exceed 20 N	Beam speed: 0.5±0.05 mm/sec			
Temperature	COG	h a within 0 (20 mm = 1 %)			
Characteristics	From -55 ℃ to 125 ℃, Capacitance change should	DE WITNIN U±3Uppm/ C			

D. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260 +0/-5 $^{\circ}$ C, 30sec.), Meet IPC/JEDEC J-STD-020 D Standard



A Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications, please contact our sales personnel or application engineers.

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The products listed in this Specification sheet are **NOT** designed and manufactured for any use and applications set forth below.

Please note that any misuse of the products deviating from products specifications or information provided in this Spec sheet may cause serious property damages or personal injury.

We will **NOT** be liable for any damages resulting from any misuse of the products, specifically including using the products for high reliability applications as listed below.

If you have any questions regarding this 'Limitation of Use and Application', you should first contact our sales personnel or application engineers.

- ① Aerospace/Aviation equipment
- ② Medical equipment
- 3 Military equipment
- 4 Disaster prevention/crime prevention equipment
- ⑤ Power plant control equipment
- 6 Atomic energy-related equipment
- ① Undersea equipment
- 8 Traffic signal equipment
- Data-processing equipment
- @ Electric heating apparatus, burning equipment
- Safety equipment
- @ Any other applications with the same as or similar complexity or reliability to the applications